

NCE N-Channel Super Trench II Power MOSFET

Description

The series of devices uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\text{DS(ON)}}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

Application

- DC/DC Converter
- •Ideal for high-frequency switching and synchronous rectification

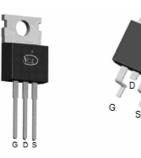
General Features

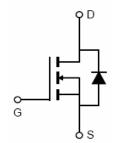
- V_{DS} =100V, I_D =135A $R_{DS(ON)}$ =3.65m Ω , typical (TO-220)@ V_{GS} =10V $R_{DS(ON)}$ =3.5m Ω , typical (TO-263)@ V_{GS} =10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating
- Pb-free Mold Compound

100% UIS TESTED! 100% ΔVds TESTED!

TO-220

TO-263





Schematic Diagram

Package Marking and Ordering Information

		<u> </u>			
Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP039N10M	NCEP039N10M	TO-220	-	-	-
NCEP039N10MD	NCEP039N10MD	TO-263	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	100	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	135	Α
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	108	Α
Pulsed Drain Current	I _{DM}	540	А
Maximum Power Dissipation	P _D	220	W
Derating factor		1.47	W/°C
Avalanche Current ^(Note 1)	I _{AR}	55	Α
Single pulse avalanche energy (Note 5)	E _{AS}	1156	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 175	$^{\circ}$ C

Thermal Characteristic

Thermal Resistance,Junction-to-Case ^(Note 2)	R _{θJC}	0.68	°C/W
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ hetaJA}$	50	°C/W



NCEP039N10M, NCEP039N10MD

Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition		Min	Тур	Max	Unit	
Off Characteristics								
Drain-Source Breakdown Voltage	BV _{DSS}	V_{GS} =0 V I_D =250 μ A		100		-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V		-	-	1	μA	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _D	vo=S=0V	-	-	±100	nA	
On Characteristics (Note 3)								
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_D=250\mu A$		2.0	3.0	4.0	V	
Drain-Source On-State Resistance	D	V _{GS} =10V, I _D =65A	TO-220	-	3.65	3.9	mΩ	
Dialii-Source Oil-State Resistance	R _{DS(ON)}	VGS-10V, ID-03A	TO-263		3.5	3.9	mΩ	
Gate resistance	R_G			-	1.5	-	Ω	
Forward Transconductance	g FS	V _{DS} =5V,I _D =65A			90	-	S	
Dynamic Characteristics (Note4)								
Input Capacitance	C _{lss}	V _{DS} =50V,V _{GS} =0V, F=1.0MHz		-	7450	9685	PF	
Output Capacitance	Coss			-	618	803	PF	
Reverse Transfer Capacitance	C _{rss}			-	37	60	PF	
Switching Characteristics (Note 4)								
Turn-on Delay Time	t _{d(on)}	V_{DD} =50V, I_{D} =65A V_{GS} =10V, R_{G} =1.6 Ω		-	20	-	nS	
Turn-on Rise Time	t _r			-	11.5	-	nS	
Turn-Off Delay Time	t _{d(off)}			-	48	-	nS	
Turn-Off Fall Time	t _f			-	10	-	nS	
Total Gate Charge	Q_g	V _{DS} =50V,I _D =65A, V _{GS} =10V		-	116	150	nC	
Gate-Source Charge	Q _{gs}			-	39	50	nC	
Gate-Drain Charge	Q_{gd}			-	32	42	nC	
Drain-Source Diode Characteristics								
Diode Forward Voltage (Note 3)	V_{SD}	V _{GS} =0V,I _S =65A		-		1.2	V	
Diode Forward Current (Note 2)	Is			-	-	135	Α	
Reverse Recovery Time	t _{rr}	$T_J = 25^{\circ}C, I_F = I_S$		-	76	-	nS	
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$		-	150	-	nC	

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. The value of $R_{\theta,JA}$ is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25° C. The value in any given application depends on the user's specific board design, and the maximum temperature of 175° C may be used if the PCB allows it.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\text{C}$,VDD=50V,VG=10V,L=0.5mH,Rg=25 Ω



Typical Electrical and Thermal Characteristics

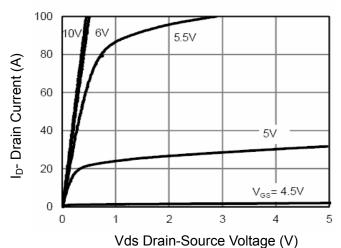


Figure 1 Output Characteristics

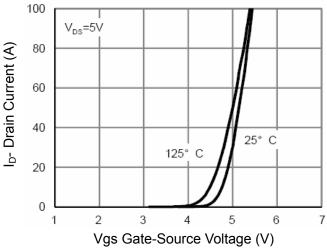
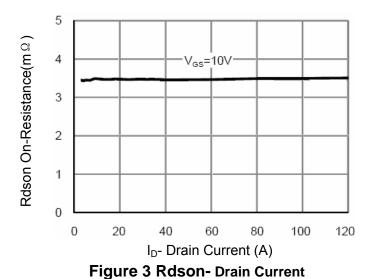


Figure 2 Transfer Characteristics



2.2

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Figure 4 Rdson-Junction Temperature

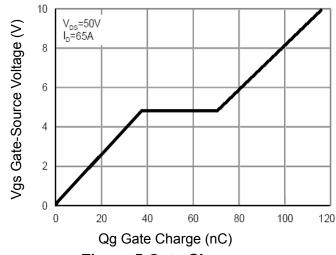


Figure 5 Gate Charge

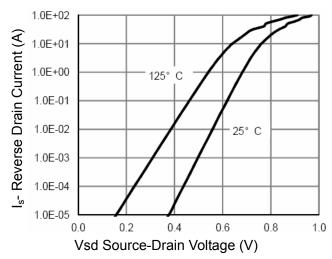


Figure 6 Source- Drain Diode Forward



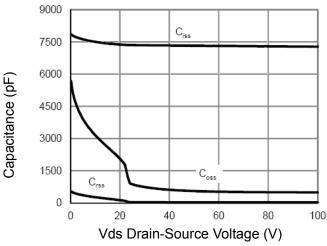


Figure 7 Capacitance vs Vds

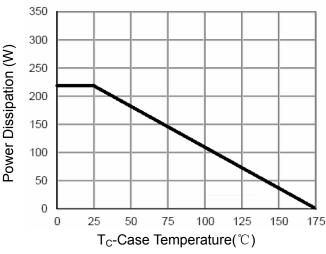


Figure 9 Power De-rating

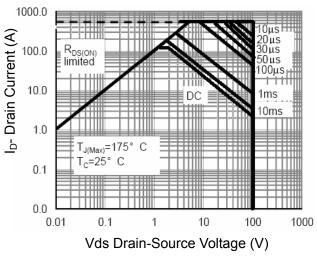


Figure 8 Safe Operation Area

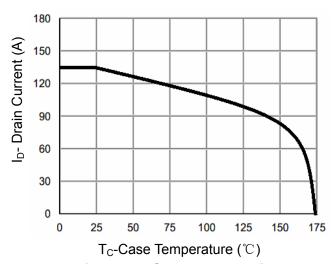
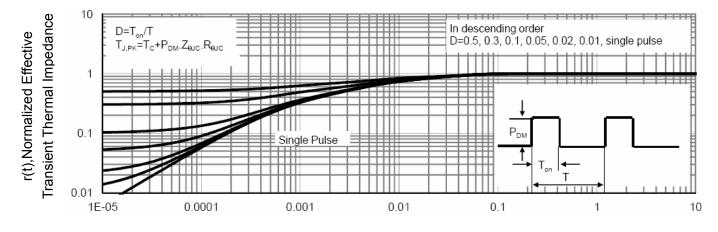


Figure 10 Current De-rating

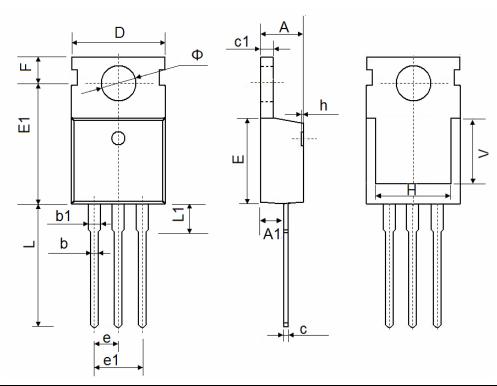


Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance



TO-220-3L Package Information

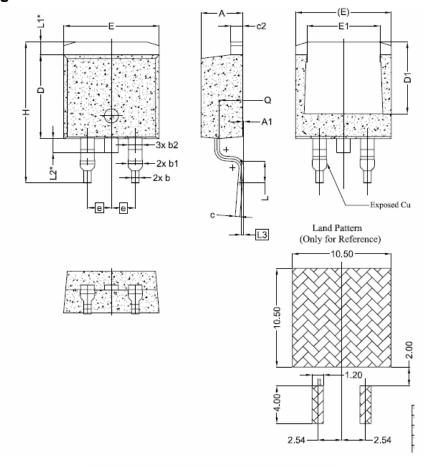


Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
Е	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.54	0 TYP.	0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	6.90	6.900 REF.		REF.	
Ф	3.400	3.800	0.134	0.150	



NCEP039N10M, NCEP039N10MD

TO-263-2L Package Information



SYMBOL	DIMENSIONS				
SYMBOL	MIN.	NOM.	MAX.		
Α	4.24	4.44	4.64		
A1	0.00	0.10	0.25		
b	0.70	0.80	0.90		
b1	1.20	1.55	1.75		
b2	1,20	1,45	1,70		
С	0.40	0.50	0.60		
c2	1,15	1,27	1,40		
D	8.82	8.92	9.02		
D1	6.86 7.65		_		
E	9.96 10.16		10.36		
E1	6.89 7.77		7.89		
е	2.54 BSC				
Н	14,61 15,00		15,88		
L	1.78 2.32		2.79		
L1	1.36 REF.				
L2	1.50 REF.				
L3	0.25 BSC				
Q	2.30	2.70			



NCEP039N10M, NCEP039N10MD

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DMN1017UCP3-7 EFC2J004NUZTDG P85W28HP2F-7071 DMN1053UCP4-7 NTE2384 DMC2700UDMQ-7 DMN2080UCB4-7
DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B IPS60R3K4CEAKMA1 DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 IPS60R360PFD7SAKMA1
DMN2990UFB-7B SSM3K35CT,L3F IPLK60R1K0PFD7ATMA1 2N7002W-G MCAC30N06Y-TP IPWS65R035CFD7AXKSA1
MCQ7328-TP SSM3J143TU,LXHF DMN12M3UCA6-7 PJMF280N65E1_T0_00201 PJMF380N65E1_T0_00201
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